Vishay Siliconix

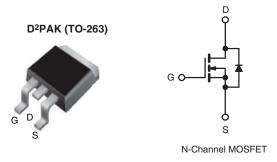
COMPLIANT

HALOGEN

FREE

E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	550				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.145				
Q _g (Max.) (nC)	86				
Q _{gs} (nC)	14				
Q _{gd} (nC)	25				
Configuration	Single				



FEATURES

- Low figure-of-merit (FOM): Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATONS

- Hard switched topologies
- Power factor correction power supplies (PFC)
- Switch mode power supplies (SMPS)
- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting

ORDERING INFORMATION			
Package	D ² PAK (TO-263)		
Lead (Pb)-free and Halogen-free	SiHB25N50E-GE3		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	500	V
Gate-Source Voltage			V_{GS}	± 30	7
Continuous Prais Current (T = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	26	А
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C		16	
Pulsed Drain Current ^a			I _{DM}	50	
Linear Derating Factor				0.2	W/°C
Single Pulse Avalanche Energy b			E _{AS}	273	mJ
Maximum Power Dissipation			P_{D}	250	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	V _{DS} = 0 V t	$V_{DS} = 0 \text{ V to } 80 \% V_{DS}$		65	V/ns
Reverse Diode dV/dt ^d			dV/dt	25	V/IIS
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.4 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$.

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.5	C/VV



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							,
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.59	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Octo Course Lockers	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage			V _{GS} = ± 30 V	-	-	± 1	μΑ
Zava Cata Valtaga Dvain Couvent		V _{DS} =	V _{DS} = 500 V, V _{GS} = 0 V		-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	25	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.125	0.145	Ω
Forward Transconductance	g _{fs}	V _{DS}	= 30 V, I _D = 12 A	-	6.6	-	S
Dynamic							
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	1980	=.	
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	105	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	8	-	pF
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		-	105	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	285	-	
Total Gate Charge	Qg				57	86	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 12 \text{ A}, V_{DS} = 400 \text{ V}$	-	14	-	nC
Gate-Drain Charge	Q _{gd}			-	25	-	
Turn-On Delay Time	t _{d(on)}			-	19	38	
Rise Time	t _r	V _{DD} = 400 V, I _D = 12 A		-	36	72	
Turn-Off Delay Time	t _{d(off)}	$R_g = 1$	9.1 Ω , $V_{GS} = 10 \text{ V}$	-	57	86	ns -
Fall Time	t _f			-	29	58	
Gate Input Resistance	R_g	f = 1 MHz, open drain		-	0.56	-	Ω
Drain-Source Body Diode Characteristic							
Continuous Source-Drain Diode Current	Is	MOSFET symi	MOSFET symbol showing the		-	12	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	50	A
Diode Forward Voltage	V_{SD}	T _J = 25 °C, I _S = 16.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	338	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S,$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	5.3	-	μC
Reverse Recovery Current	I _{RRM}			-	29	-	Α

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

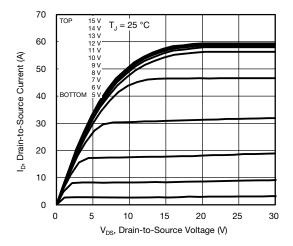


Fig. 1 - Typical Output Characteristics

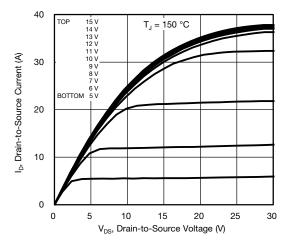


Fig. 2 - Typical Output Characteristics

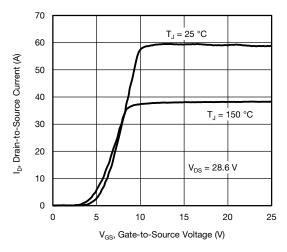


Fig. 3 - Typical Transfer Characteristics

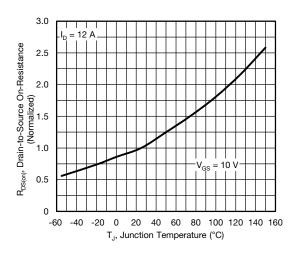


Fig. 4 - Normalized On-Resistance vs. Temperature

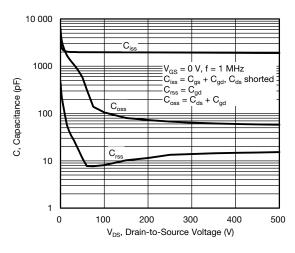


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

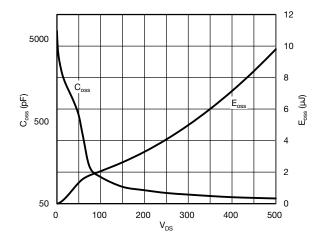


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}



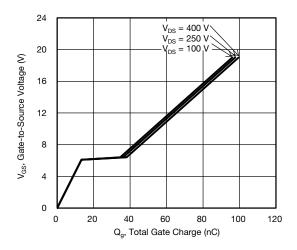


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

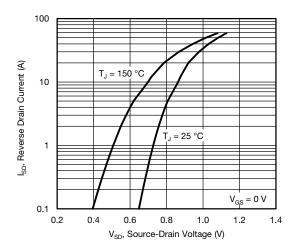


Fig. 8 - Typical Source-Drain Diode Forward Voltage

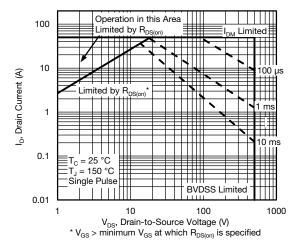


Fig. 9 - Maximum Safe Operating Area

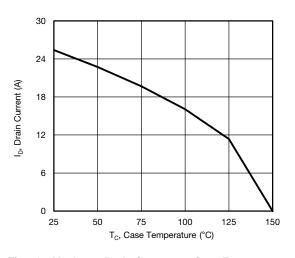


Fig. 10 - Maximum Drain Current vs. Case Temperature

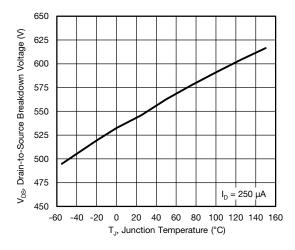


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature



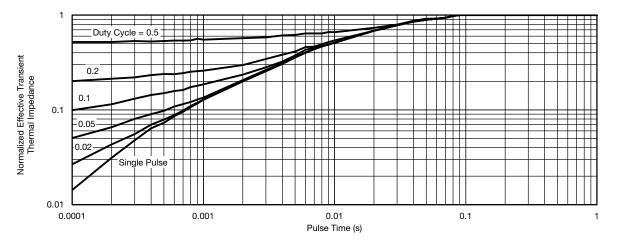


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

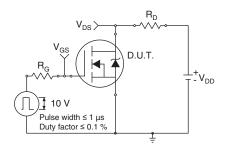


Fig. 13 - Switching Time Test Circuit

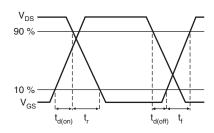


Fig. 14 - Switching Time Waveforms

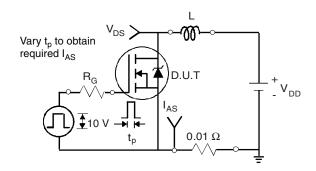


Fig. 15 - Unclamped Inductive Test Circuit

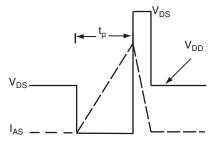


Fig. 16 - Unclamped Inductive Waveforms

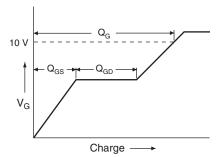


Fig. 17 - Basic Gate Charge Waveform

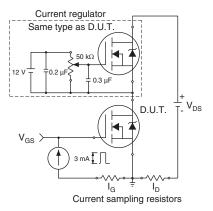
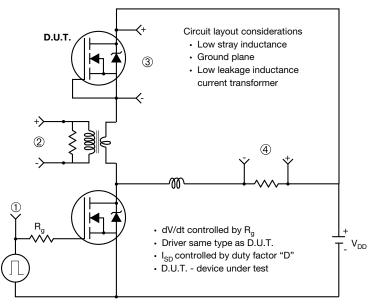


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



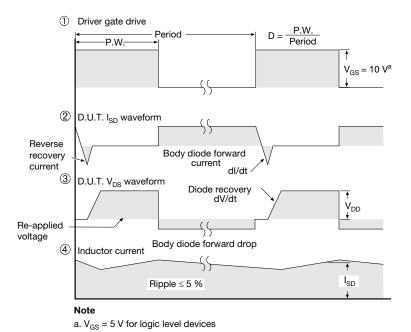


Fig. 19 - For N-Channel

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TO-263AB (HIGH VOLTAGE)







View A - A

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
D1	6.86	-	0.270	-
Е	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	i
е	2.54 BSC		0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	ı	0.066
L2	-	1.78	-	0.070
L3	0.25 BSC		0.010 BSC	
L4	4.78	5.28	0.188	0.208

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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